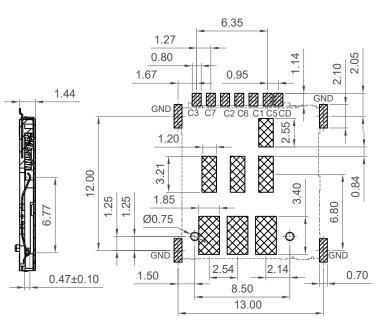


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7x 0.45 2x 13.09

2

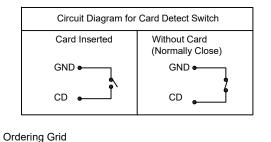
1

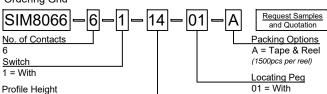


 Recommended PCB Layout

 (Viewed from Component Side - Tolerance:±0.05mm)

 ☑ Solder Area
 ☑ Keep Out Area
 ☐ Component Outline





14 = 1.44mm

4

3

Specifications

Material

Housing&Slide : High Temperature Thermoplastic, UL94V-0, Black Contact Terminal: Copper Alloy Metallic Shell: Stainless Steel Spring: SWP-B Link: Stainless Steel

Plating

Contact : Contact Area: Gold Flash over Nickel Soldering Tail: Gold Flash over Nickel Shell:

Soldering Tail: Gold Flash over Nickel Spring&Link: Cleaning

Electrical

Voltage rating: 30V AC/DC Current Rating: 1.0 Amp AC/DC Max. Contact Resistance: Signal contact: 100 mΩ Max. CD to GND: 200 mΩ Max. Dielectric Withstanding Voltage:500V AC (60 Sec Min.) Insulation Resistance: 1000 MΩ Min.@500V DC

Mechanical & Environmental Operating Temperature: -40°C to +85°C Durabillity : 5,000 cycles

Part Number			Product Description								
SIM8066			Nano SIM Card Connector								
Drawing D	ate		Push-Push Type, SMT, 6Pin, 1.44mm Profile								
19th March 2021											
By	CC	Tolerances (E		Units:			This drawing is confidential and	1 🗨			
Detail	Drawing Release	Length X.X ± 0.30	Angle Metric (mm)		\bigcirc	COpyright of Global Connector Technology, Ltd (GCT). This drawing must not be copied	www.gct.co				
Revision	A1	X.XX ± 0.20	± 2°		2011/65/EU	S	or disclosed without written	Not to	Drawn By	Sheet No.	
Date	22/09/21	X.XXX ± 0.10		3rd Angle Projection	Deca-BDE		consent. E & OE	Scale	CC	1/3	
5			6			7			8		

